



DMG3407SSN

P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
2014	50mΩ @ V _{GS} = -10V	-4.0A
-30V	72mΩ @ V _{GS} = -4.5V	-3.3A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

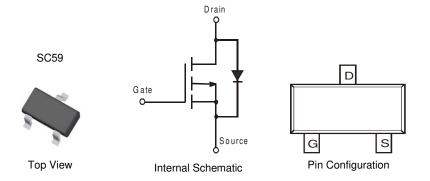
- Load Switch
- DC-DC Converters
- Power Management Functions

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SC59
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish —Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 3
- Terminal Connections: See Diagram
- Weight: 0.014 grams (Approximate)



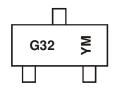
Ordering Information (Note 4)

Part Number	Case	Packaging
DMG3407SSN-7	SC59	3000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



G32 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key

Year	201	0	~		2016	20	17	2018		2019	2	2020
Code	X		~		D	E		F		G		Н
Month	Jan	Feb	Mar	A	Mari		11		0	0-1		
	Jaii	reb	war	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	-30	V		
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Duain Courset (Note C) V 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-4.0 -3.2	А
Continuous Drain Current (Note 6) V _{GS} = -10V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	I _D	-4.6 -3.6	А
Continuos Ducin Courset (Nata C) V	I _D	-3.3 -2.6	А		
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-3.9 -3.1	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	-30	Α		
Maximum Body Diode Forward Current (Note 6)	I _S	-2.0	Α		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	Б	1.1	W	
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	P_D	0.7	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	р	166	°C/W	
Thermal Resistance, Junction to Ambient (Note 3)	t<10s	$R_{\theta JA}$	118		
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	D-	1.8	W	
Total Fower Dissipation (Note 6)	$T_A = +70^{\circ}C$	P_D	1.1		
Thermal Peristance Junction to Ambient (Note 6)	Steady state	D	98	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	71		
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	18			
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

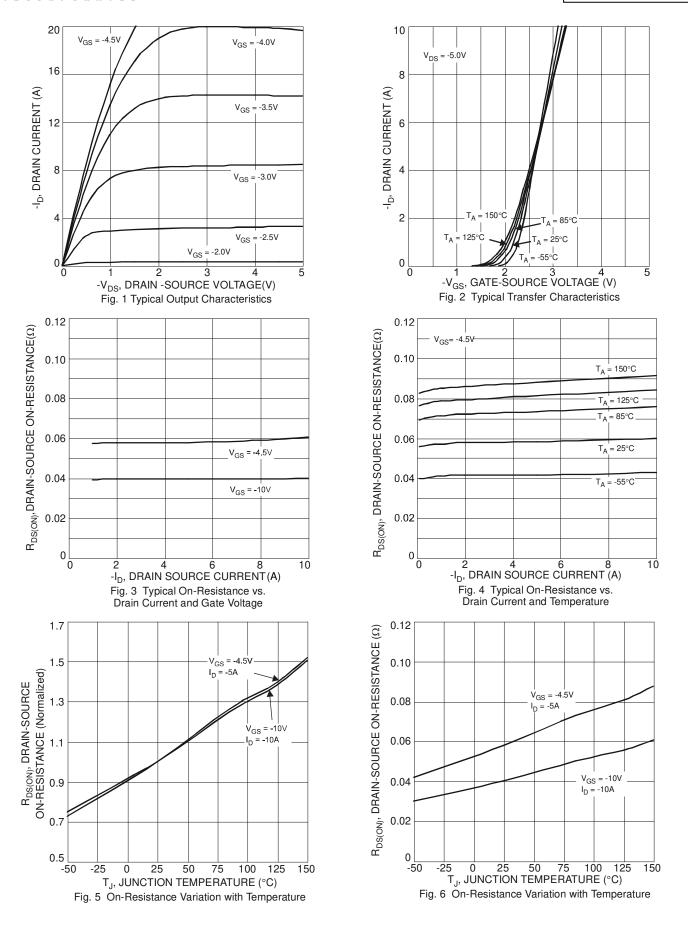
Electrical Characteristics (@ T_A = +25°C, unless otherwise stated.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	-			•		
Drain-Source Breakdown Voltage	BV _{DSS}	-30	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current, T _J = +25°C	I _{DSS}	-	-	-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	-1.0	-1.5	-2.1	٧	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance		-	39	50	mΩ	$V_{GS} = -10V, I_D = -4.1A$
Static Dialii-Source Off-Nesistance	R _{DS(ON)}	-	56	72	11122	$V_{GS} = -4.5V, I_D = -3.0A$
Forward Transfer Admittance	Y _{fs}	-	8.2	-	S	$V_{DS} = -5V, I_{D} = -4A$
Diode Forward Voltage	V_{SD}	-	-0.75	-1.1	V	$V_{GS} = 0V, I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	466	582	700		
Output Capacitance	Coss	80	114	148	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	47	76	105		I = 1.0MHZ
Gate Resistance	R_g	2	5	8	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Q_g	10.6	13.3	16		$V_{GS} = -10V, V_{DS} = -15V, I_D = -4A$
Total Gate Charge	Qg	5.2	6.5	8.5	nC	
Gate-Source Charge	Q_{gs}	1.3	1.7	2	110	$V_{GS} = -4.5V, V_{DS} = -15V, I_D = -4A$
Gate-Drain Charge	Q_{gd}	1.1	1.9	2.7		
Turn-On Delay Time	t _{D(ON)}	-	6.0	-		
Turn-On Rise Time	t _R	-	12.9	-	ns	$V_{GS} = -10V, V_{DS} = -15V,$
Turn-Off Delay Time	t _{D(OFF)}	-	35.4	-		$R_L = 3.6\Omega$, $R_G = 3\Omega$
Turn-Off Fall Time	t _F	-	30.7	-		
Reverse Recovery Time	t _{RR}	6.8	8.5	10.2	ns	1 44 41/41 4004/
Reverse Recovery Charge	Q _{RR}	5.5	7.0	8.5	nC	I _F = 4A, di/dt = 100A/µs

Notes:

- 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided. The power dissipation P_D is based on t<10s $R_{\theta JA}$
- 6. Device mounted on 1" x 1" FR-4 PCB with high coverage 2 oz. copper, single sided. The power dissipation P_D is based on t<10s R_{0JA}
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.







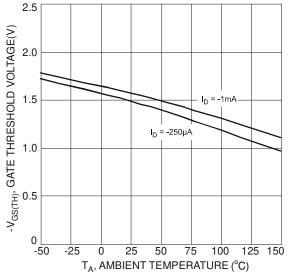
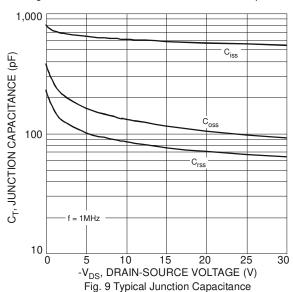
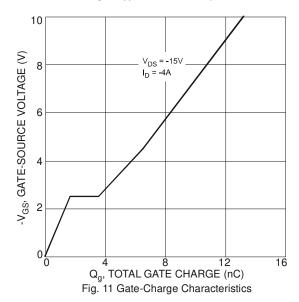
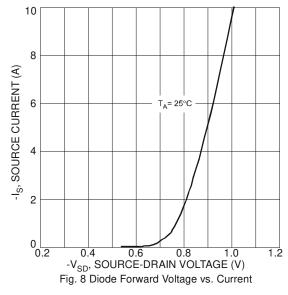


Fig. 7 Gate Threshold Variation vs. Ambient Temperature







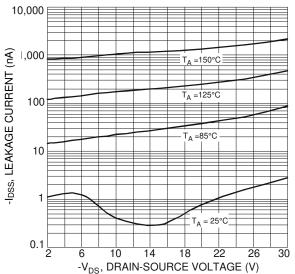


Fig. 10 Typical Drain-Source Leakage Current vs. Voltage

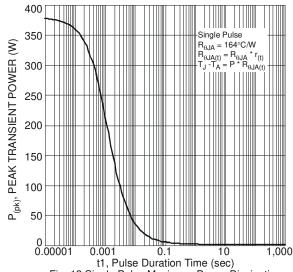
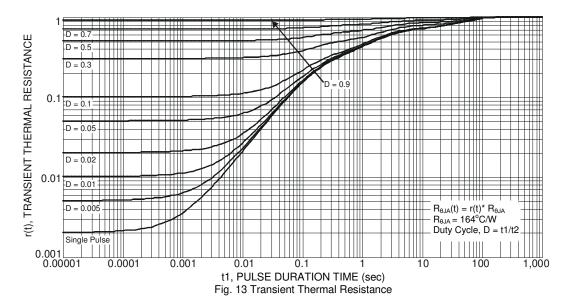


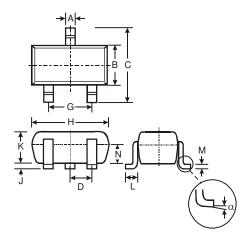
Fig. 12 Single Pulse Maximum Power Dissipation





Package Outline Dimensions

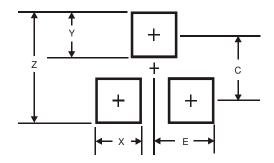
Please see http://www.diodes.com/package-outlines.html for the latest version.



SC59							
Dim	Min	Max	Тур				
Α	0.35	0.50	0.38				
В	1.50	1.70	1.60				
С	2.70	3.00	2.80				
D	-	-	0.95				
G	-						
Н	2.90	3.10	3.00				
J	0.013	0.10	0.05				
K	1.00	1.10					
L	0.35	0.55	0.40				
М	0.10	0.20	0.15				
N	0.70	0.80	0.75				
α	0°	8°	-				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
Z	3.4
Х	0.8
Υ	1.0
С	2.4
E	1.35



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